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September 21, 2001

Date

Rena Iov

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants

Whonchee Lee, Scott G. Meikle, Scott E. Moore

Application No.

09/887,767

Confirmation No.: 9072

Filed

June 21, 2001

For

MICROELECTRONIC

SUBSTRATE

HAVING

CONDUCTIVE MATERIAL WITH BLUNT CORNERED APERTURES, **AND ASSOCIATED METHODS FOR**

REMOVING CONDUCTIVE MATERIAL

Docket No.

: 108298515US2

Date

September 21, 2001

Commissioner for Patents Washington, DC 20231

TRANSMITTAL OF INFORMATION DISCLOSURE STATEMENT

Sir:

In accordance with 37 C.F.R. §§ 1.56 and 1.97 through 1.98, applicants wish to make known to the Patent and Trademark Office the references set forth on the attached form PTO/SB/08A (copies of the cited references, as required under 37 C.F.R. § 1.98, are enclosed). Although the aforesaid references are made known to the Patent and Trademark Office in compliance with applicants' duty to disclose all information of which they are aware that is believed relevant to the patentability of the above-identified application, applicants believe that their invention is patentable. As to any document supplied, applicants do not admit that it is "prior art" under 35 U.S.C. §§ 102 or 103, and

specifically reserve the right to antedate any such document, as by a showing under 35 C.F.R. § 1.131 or other method.

Please acknowledge receipt of this Information Disclosure Statement and kindly make the cited references of record in the above-identified application.

Respectfully submitted,

Perkins Coie LLP

John M. Wechkin

Registration No. 42,216

JMW:ri

Enclosures:

Postcard

Form PTO/SB/08A

Cited References (4)

P.O. Box 1247

Seattle, Washington 98111-1247

(206) 583-8888

Fax: (206) 583-8500